# NPN Transistor with Dual Series Switching Diode

### **Features**

 These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

### **Typical Applications**

- LCD Control Board
- High Speed Switching
- High Voltage Switching

### **MAXIMUM RATINGS - PNP TRANSISTOR**

| Rating                         | Symbol           | Value | Unit |
|--------------------------------|------------------|-------|------|
| Collector - Emitter Voltage    | V <sub>CEO</sub> | 80    | Vdc  |
| Collector - Base Voltage       | V <sub>CBO</sub> | 80    | Vdc  |
| Emitter - Base Voltage         | V <sub>EBO</sub> | 6.0   | Vdc  |
| Collector Current - Continuous | Ic               | 500   | mAdc |

### **MAXIMUM RATINGS - SWITCHING DIODE**

| Rating   | Symbol                            | Value       | Unit |
|--|-----------------------------------|-------------|------|
| Reverse Voltage  | $V_R$                             | 100         | V    |
| Forward Current  | I <sub>F</sub>                    | 200         | mA   |
| Non-Repetitive Peak Forward Current (Square Wave, $T_J$ = 25°C prior to surge) $t < 1$ sec $t = 1$ $\mu$ sec | I <sub>FSM</sub>                  | 1.0<br>20   | Α    |
| Operating and Storage Junction<br>Temperature Range  | T <sub>J</sub> , T <sub>stg</sub> | -55 to +150 | °C   |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

### **ESD RATINGS**

| Rating                  |     | Class | Value                     |
|-------------------------|-----|-------|---------------------------|
| Electrostatic Discharge | HBM | 3A    | 4000 V ≤ Failure < 8000 V |
|                         | MM  | M4    | Failure > 400 V           |

### THERMAL CHARACTERISTICS

| Rating  | Symbol                            | Max         | Unit        |
|---|-----------------------------------|-------------|-------------|
| Total Device Dissipation FR-5 Board,<br>(Note 1) @ T <sub>A</sub> = 25°C<br>Derate above 25°C | P <sub>D</sub>                    | 400         | mW<br>mW/°C |
| Thermal Resistance from<br>Junction-to-Ambient (Note 1)                                       | $R_{\theta JA}$                   | 313         | °C/W        |
| Total Device Dissipation FR-5 Board<br>(Note 2) T <sub>A</sub> = 25°C<br>Derate above 25°C    | P <sub>D</sub>                    | 270         | mW<br>mW/°C |
| Thermal Resistance,<br>Junction-to-Ambient (Note 2)   | $R_{\theta JA}$                   | 463         | °C/W        |
| Junction and Storage<br>Temperature Range   | T <sub>J</sub> , T <sub>stg</sub> | -55 to +150 | °C          |

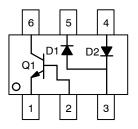
- 1.  $FR-5 = 650 \text{ mm}^2 \text{ pad}$ , 2.0 oz Cu.
- 2.  $FR-5 = 10 \text{ mm}^2 \text{ pad}$ , 2.0 oz Cu.



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# NPN Transistor with Dual Series Switching Diode





SC-74 CASE 318F

### **MARKING DIAGRAM**



3NP = Device Code M = Date Code\* ■ Pb-Free Package

(Note: Microdot may be in either location)
\*Date Code orientation may vary depending upon manufacturing location.

#### ORDERING INFORMATION

| Device       | Package            | Shipping <sup>†</sup> |
|--------------|--------------------|-----------------------|
| NSM80101MT1G | SC-74<br>(Pb-Free) | 3000 /<br>Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

## Q1: NPN TRANSISTOR ELECTRICAL CHARACTERISTICS ( $T_A = 25^{\circ}$ C unless otherwise noted)

| Characte                                    | Symbol   | Min                  | Max | Unit |     |
|---|--|----------------------|-----|------|-----|
| OFF CHARACTERISTICS                         |  |                      |     |      |     |
| Collector - Emitter Breakdown Voltage (Note | $(I_C = 1.0 \text{ mA}, I_B = 0)$                              | V <sub>(BR)CEO</sub> | 80  | -    | V   |
| Emitter - Base Breakdown Voltage            | $(I_E = 100 \ \mu A, \ I_C = 0)$                               | V <sub>(BR)EBO</sub> | 6.0 | -    | V   |
| Collector Cutoff Current                    | (V <sub>CE</sub> = 60 V, I <sub>B</sub> = 0)                   | I <sub>CES</sub>     | -   | 0.1  | μΑ  |
| Collector Cutoff Current                    | (V <sub>CB</sub> = 80 V, I <sub>E</sub> = 0)                   | I <sub>CBO</sub>     | -   | 0.1  | μΑ  |
| ON CHARACTERISTICS (Note 3)                 |  |                      |     |      |     |
| DC Current Gain                             | (I <sub>C</sub> = 10 mA, V <sub>CE</sub> = 1.0 V)              | h <sub>FE</sub>      | 120 | -    | -   |
| Collector - Emitter Saturation Voltage      | (I <sub>C</sub> = 100 mA, I <sub>B</sub> = 10 mA)              | V <sub>CE(sat)</sub> | -   | 0.3  | V   |
| Base - Emitter Saturation Voltage           | (I <sub>C</sub> = 10 mA, V <sub>CE</sub> = 5.0 Vdc)            | V <sub>BE(sat)</sub> | _   | 1.2  | V   |
| SMALL-SIGNAL CHARACTERISTICS                |  |                      |     |      |     |
| Current - Gain - Bandwidth Product          | (I <sub>C</sub> = 10 mA, V <sub>CE</sub> = 5.0 V, f = 100 MHz) | f <sub>T</sub>       | 150 | -    | MHz |

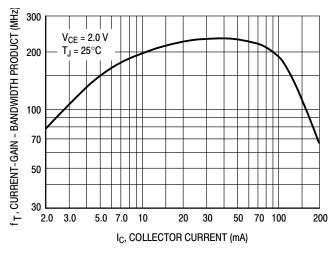
<sup>3.</sup> Pulse Test: Pulse Width  $\leq 300~\mu\text{s},~\text{Duty Cycle} \leq 2.0\%.$ 

### **D1, D2: SWITCHING DIODE** ( $T_A = 25^{\circ}C$ unless otherwise noted)

| Characteristic   | Symbol            | Min              | Max                        | Unit |
|--|-------------------|------------------|----------------------------|------|
| OFF CHARACTERISTICS  |                   | •                | •                          |      |
| Reverse Breakdown Voltage  | V <sub>(BR)</sub> | 75               | -                          | V    |
| Reverse Voltage Leakage Current $ (V_R = 75 \text{ V}) $ $ (V_R = 20 \text{ V}, T_J = 150^{\circ}\text{C}) $ $ (V_R = 75 \text{ V}, T_J = 150^{\circ}\text{C}) $ | I <sub>R</sub>    | -<br>-<br>-      | 1.0<br>30<br>100           | μΑ   |
| Diode Capacitance $\label{eq:VR} \left(V_{R}=0\;V,f=1.0\;\text{MHz}\right)$  | C <sub>D</sub>    | -                | 2.0                        | pF   |
| Forward Voltage $\begin{array}{c} (I_F=1.0\text{ mA})\\ (I_F=10\text{ mA})\\ (I_F=50\text{ mA})\\ (I_F=50\text{ mA}) \end{array}$                                | V <sub>F</sub>    | -<br>-<br>-<br>- | 715<br>855<br>1000<br>1250 | mV   |
| Reverse Recovery Time $ (I_F = I_R = 10 \text{ mA},  i_{R(REC)} = 1.0 \text{ mA},  R_L = 100  \Omega) $  | t <sub>rr</sub>   | -                | 6.0                        | ns   |
| Forward Recovery Voltage $ (I_F = 10 \text{ mA, } t_r = 20 \text{ ns)} $   | V <sub>FR</sub>   | -                | 1.75                       | V    |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

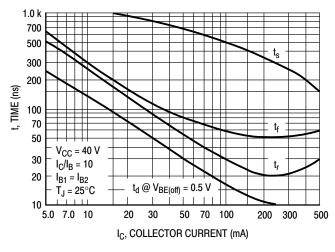
### **TYPICAL CHARACTERISTICS**



80 60 40 C, CAPACITANCE (pF) Cibo 20 10 8.0 6.0 0.2 0.5 1.0 2.0 5.0 10 50 100 0.1 V<sub>R</sub>, REVERSE VOLTAGE (VOLTS)

Figure 1. Current-Gain — Bandwidth Product

Figure 2. Capacitance



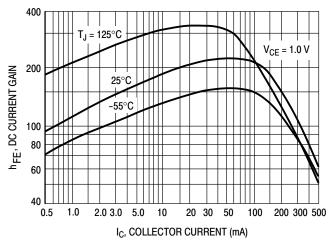
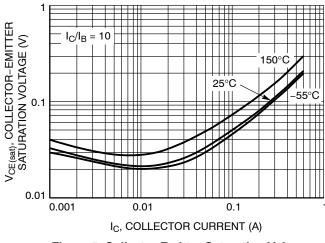


Figure 3. Switching Time

Figure 4. DC Current Gain



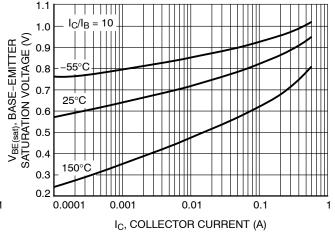


Figure 5. Collector Emitter Saturation Voltage vs. Collector Current

Figure 6. Base Emitter Saturation Voltage vs. Collector Current

### **TYPICAL CHARACTERISTICS**

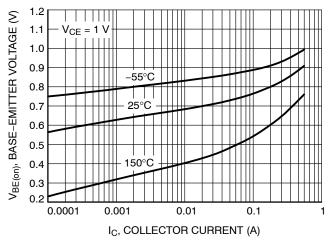


Figure 7. Base Emitter Voltage vs. Collector Current

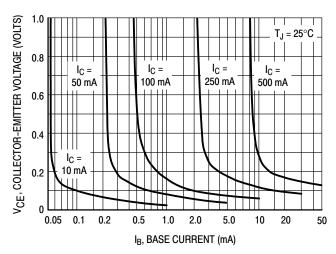
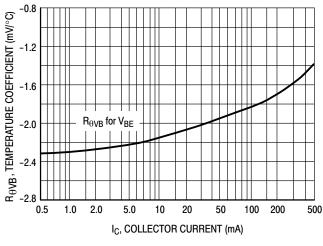


Figure 8. Collector Saturation Region





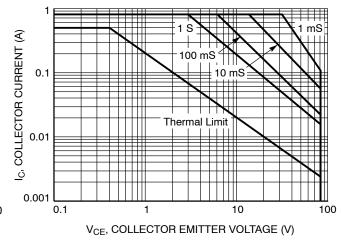


Figure 10. Safe Operating Area

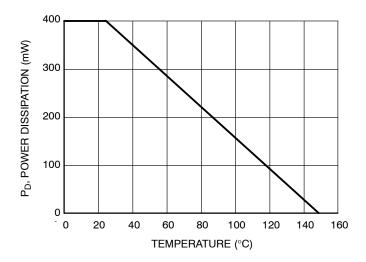
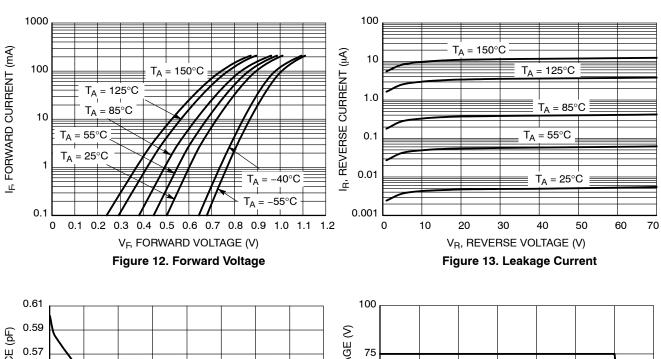
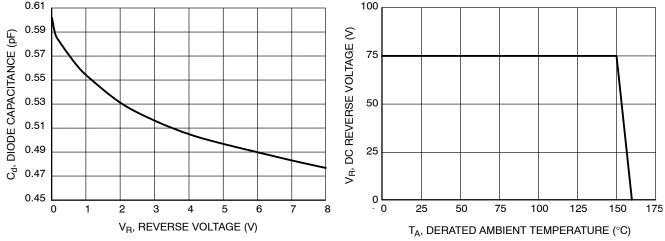


Figure 11. Operating Temperature Derating

### **TYPICAL CHARACTERISTICS**









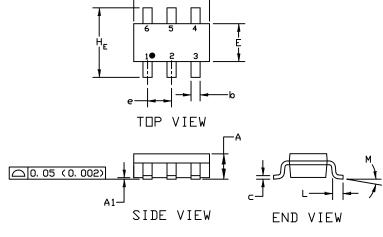
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**DATE 07 OCT 2021** 

#### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994
- 2. CONTROLLING DIMENSION: INCHES
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE BASE MATERIAL.

|                | MI    | LLIMETER | 25    |        | INCHES |        |
|----------------|-------|----------|-------|--------|--------|--------|
| DIM            | MIN.  | N□M.     | MAX.  | MIN.   | N□M.   | MAX.   |
| A              | 0. 90 | 1. 00    | 1. 10 | 0. 035 | 0. 039 | 0. 043 |
| A1             | 0. 01 | 0. 06    | 0. 10 | 0. 001 | 0. 002 | 0. 004 |
| b              | 0. 25 | 0. 37    | 0. 50 | 0. 010 | 0. 015 | 0. 020 |
| С              | 0.10  | 0. 18    | 0. 26 | 0. 004 | 0. 007 | 0. 010 |
| D              | 2. 90 | 3. 00    | 3. 10 | 0. 114 | 0. 118 | 0. 122 |
| E              | 1. 30 | 1. 50    | 1. 70 | 0. 051 | 0. 059 | 0. 067 |
| е              | 0. 85 | 0. 95    | 1. 05 | 0. 034 | 0. 037 | 0. 041 |
| Η <sub>E</sub> | 2. 50 | 2. 75    | 3. 00 | 0. 099 | 0. 108 | 0. 118 |
| L              | 0. 20 | 0. 40    | 0. 60 | 0. 008 | 0. 016 | 0. 024 |
| М              | 0*    |          | 10*   | 0*     |        | 10*    |



### GENERIC MARKING DIAGRAM\*

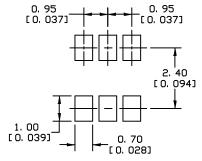


XXX = Specific Device Code

M = Date Code ■ = Pb-Free Package

(Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.



For additional information on our Pb-Free strategy and soldering details, please download the UN Seniconductor Soldering and Mounting Techniques Reference Manual, SULDERRM/D.

SOLDERING FOOTPRINT

| STYLE 1:<br>PIN 1. CATHODE<br>2. ANODE<br>3. CATHODE<br>4. CATHODE<br>5. ANODE<br>6. CATHODE     | STYLE 2: PIN 1. NO CONNECTION 2. COLLECTOR 3. EMITTER 4. NO CONNECTION 5. COLLECTOR 6. BASE | STYLE 3: PIN 1. EMITTER 1 2. BASE 1 3. COLLECTOR 2 4. EMITTER 2 5. BASE 2 6. COLLECTOR 1 | STYLE 4: PIN 1. COLLECTOR 2 2. EMITTER 1/EMITTER 2 3. COLLECTOR 1 4. EMITTER 3 5. BASE 1/BASE 2/COLLECTOR 3 6. BASE 3 | STYLE 5:<br>PIN 1. CHANNEL 1<br>2. ANODE<br>3. CHANNEL 2<br>4. CHANNEL 3<br>5. CATHODE<br>6. CHANNEL 4 | STYLE 6:<br>PIN 1. CATHODE<br>2. ANODE<br>3. CATHODE<br>4. CATHODE<br>5. CATHODE<br>6. CATHODE |
|--|---|--|---|--|--|
| STYLE 7:<br>PIN 1. SOURCE 1<br>2. GATE 1<br>3. DRAIN 2<br>4. SOURCE 2<br>5. GATE 2<br>6. DRAIN 1 | STYLE 8: PIN 1. EMITTER 1 2. BASE 2 3. COLLECTOR 2 4. EMITTER 2 5. BASE 1 6. COLLECTOR 1    | STYLE 9: PIN 1. EMITTER 2 2. BASE 2 3. COLLECTOR 1 4. EMITTER 1 5. BASE 1 6. COLLECTOR 2 | STYLE 10: PIN 1. ANODE/CATHODE 2. BASE 3. EMITTER 4. COLLECTOR 5. ANODE 6. CATHODE                                    | STYLE 11: PIN 1. EMITTER 2. BASE 3. ANODE/CATHODI 4. ANODE 5. CATHODE 6. COLLECTOR                     | E  |

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